

XPS analysis of pyrite thin films

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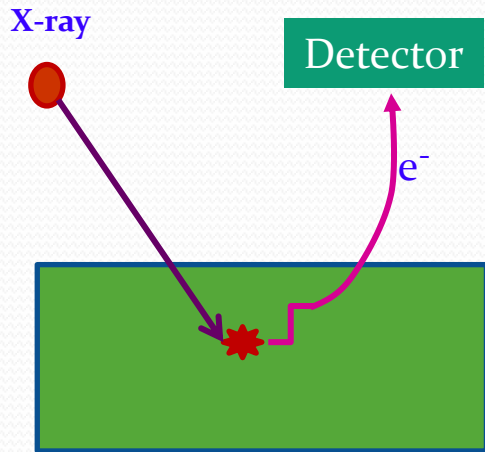
August 3, 2010

Outline

- **Introduction of XPS**
- **Pyrite thin films on the glass**
 - Na migration to the surface
 - Ar sputtering effect
- **Pyrite thin films on the quartz**
 - Removal of oxidation layers on the surface
 - Time-dependent oxidation study
- **Pyrite thin films on the Si substrate**
 - Synchrotron radiation (Advance Light Source in Berkeley National Labs)
 - Surface chemical states of pyrite thin films on the Si substrate

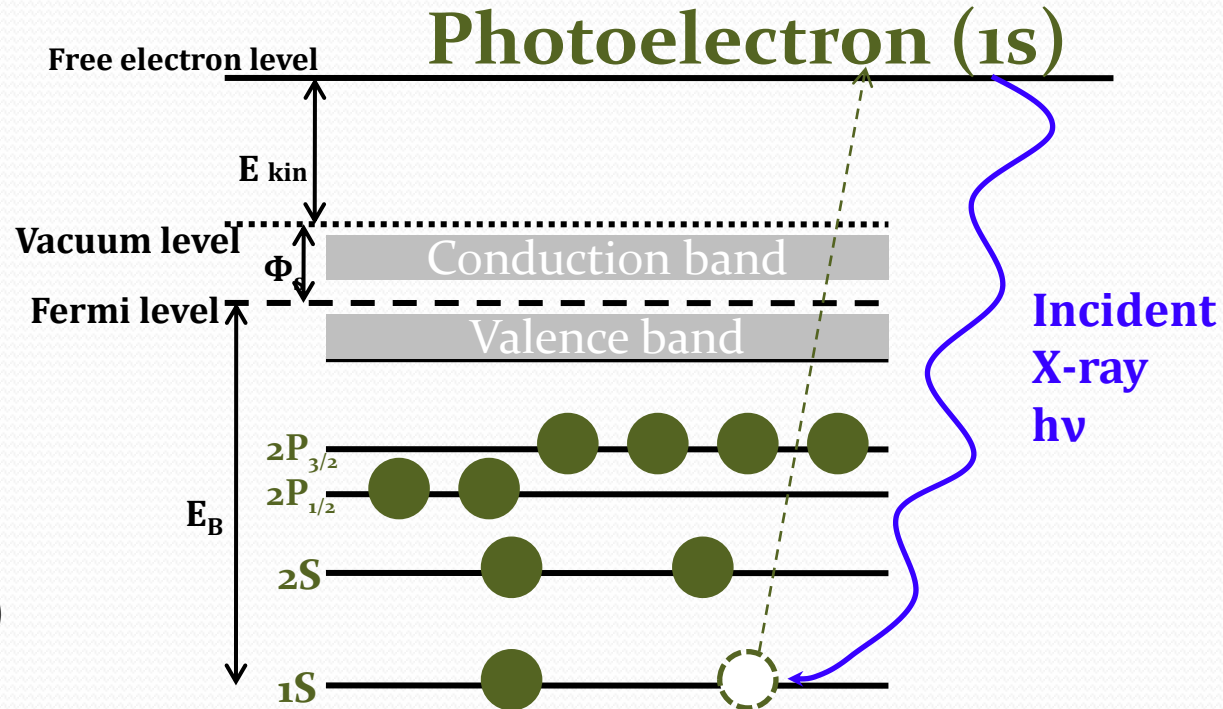
The principle of X-ray photoelectron spectroscopy (XPS)

Photoelectron effect



Ultra-high vacuum (<10⁻⁹ torr) is required.

XPS energy level diagram

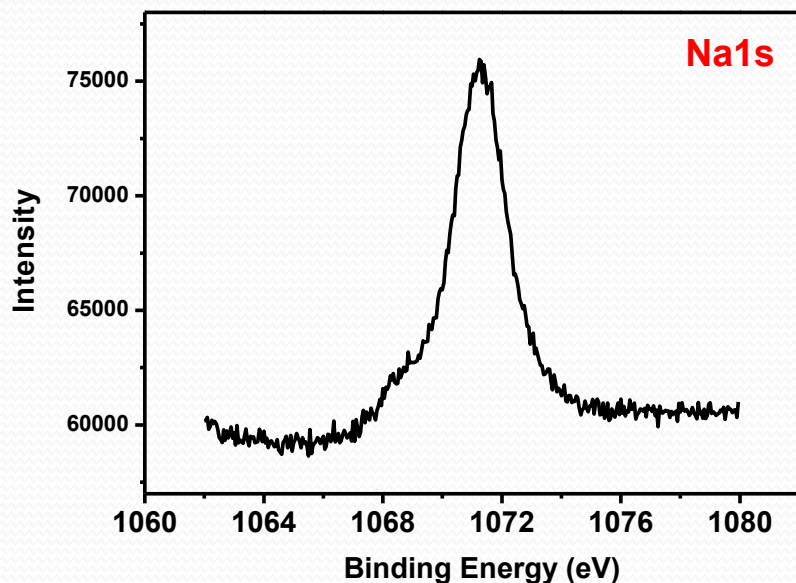
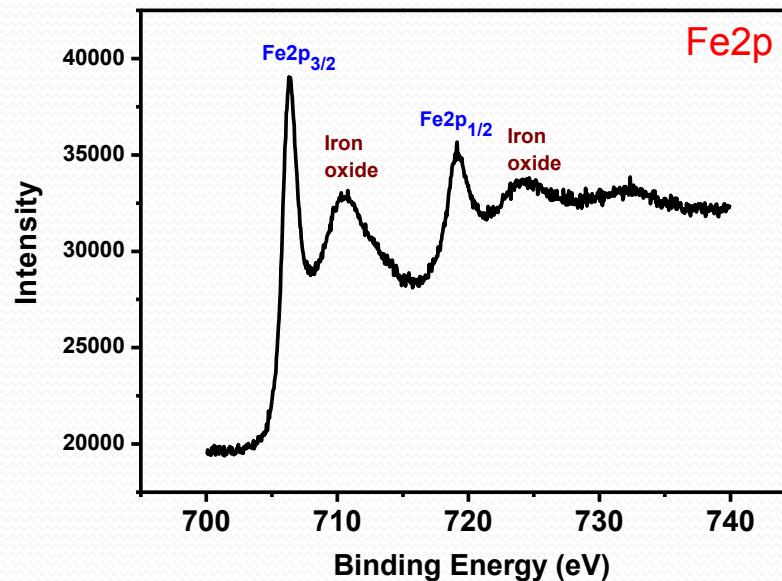
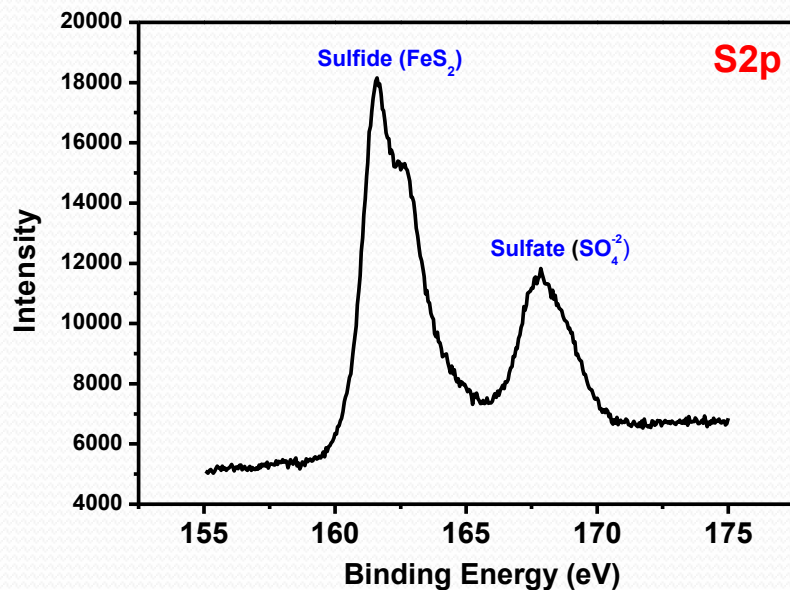


$$E_{kin} = h\nu - E_B - \Phi_s$$

E_{kin} : The kinetic energy of ejected photoelectrons; E_B : Binding Energy

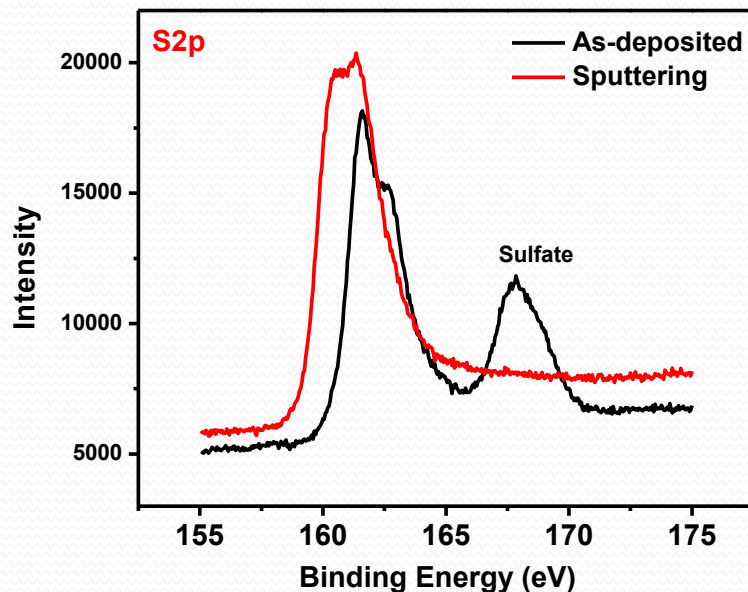
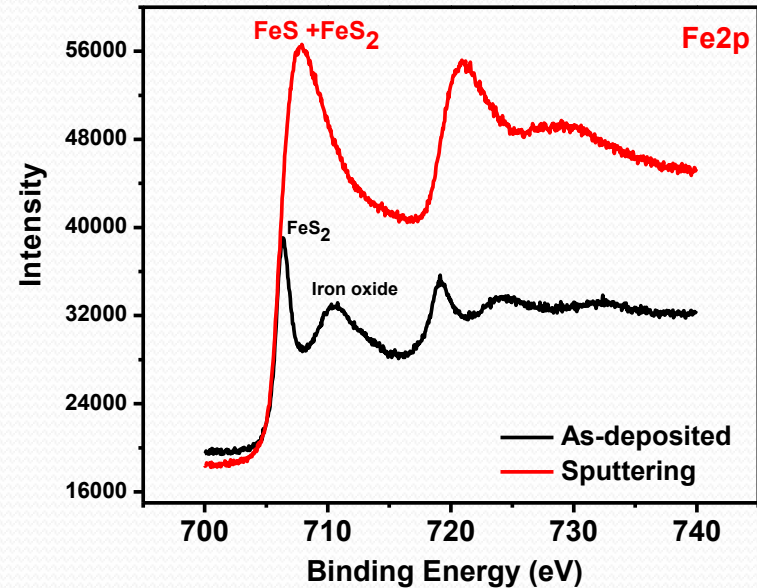
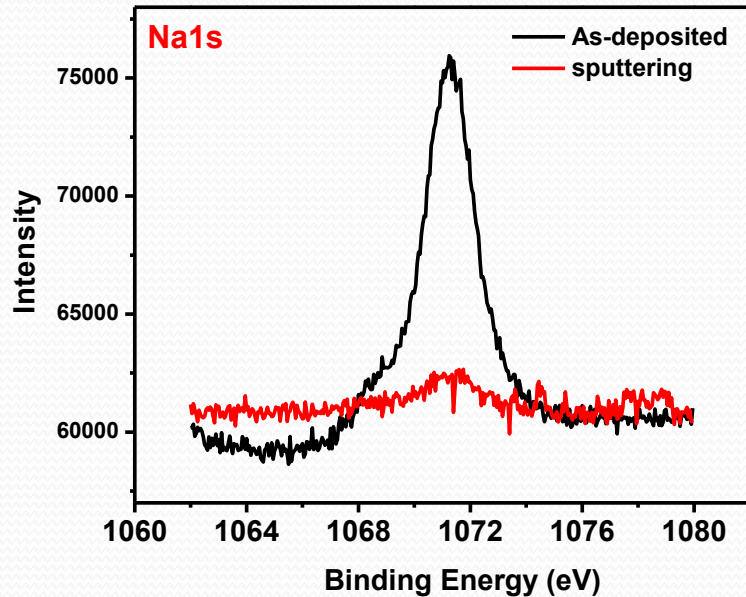
$h\nu$: The energy of the incident X-ray photons. Φ_s : Work function term (almost constant)

Pyrite thin films on the glass



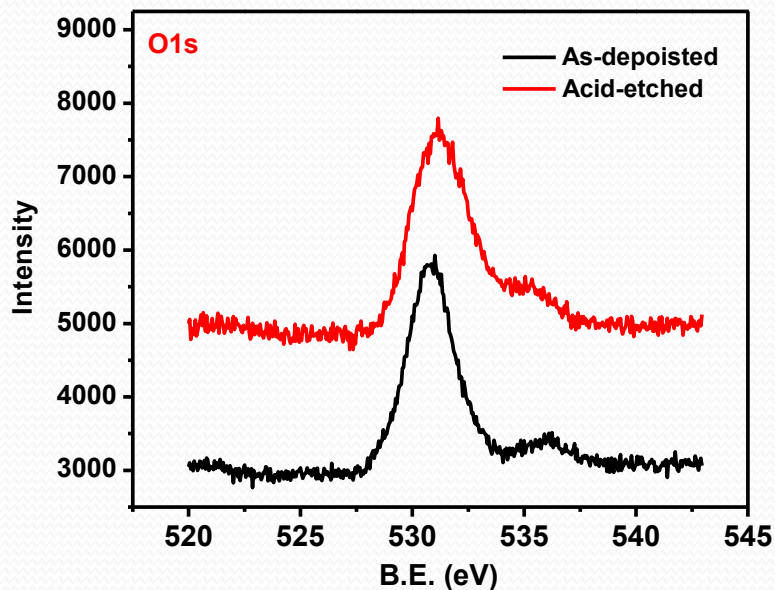
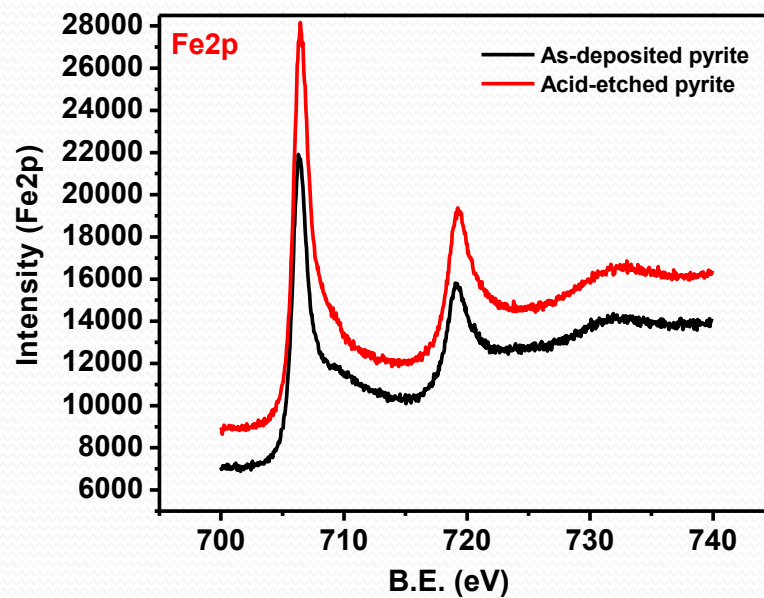
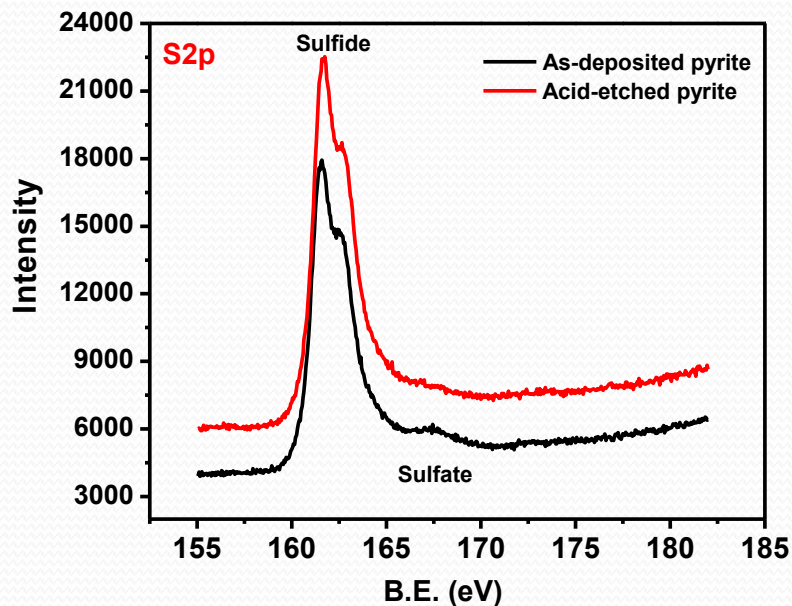
- The pyrite has been **oxidized**.
- **Na exists** on the surface of the pyrite thin film.

As-deposited VS Sputtered



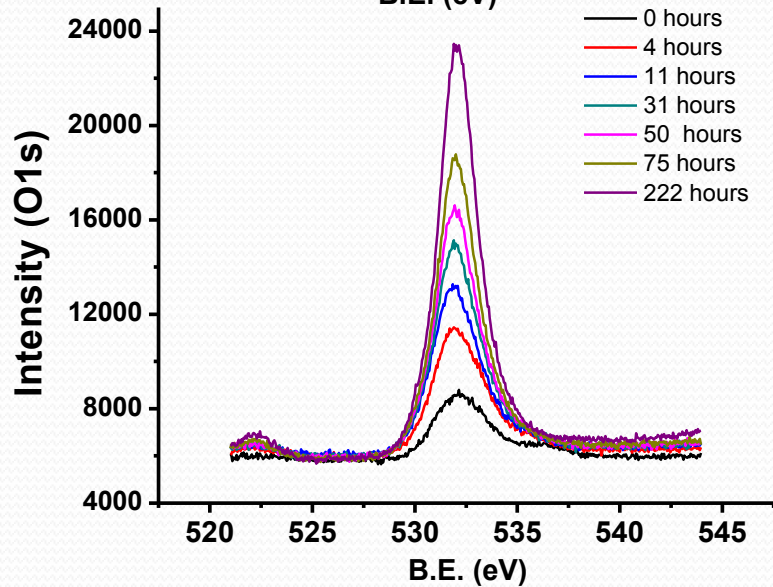
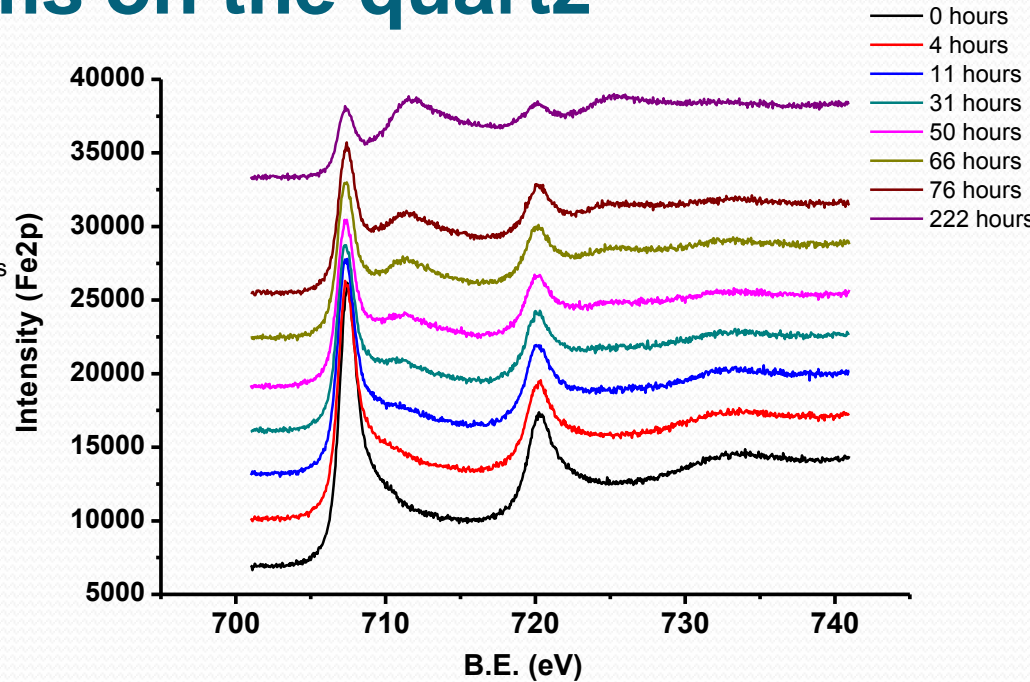
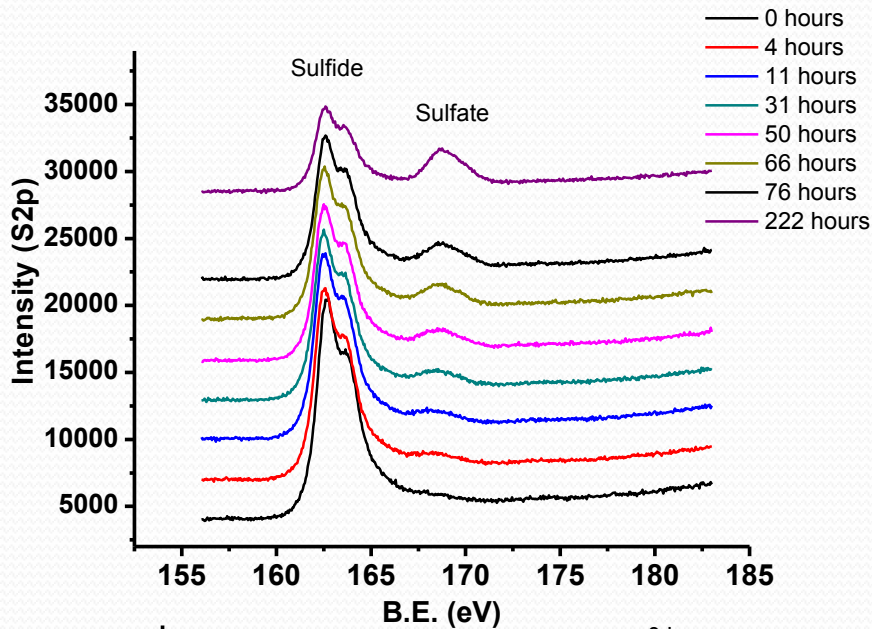
- **Sputtering condition:** $5 \cdot 10^{-5}$ torr Ar, 2 KV (beam energy), 20mA (emission current), 5 mins.
- **Na is removed** by Ar sputtering which indicates Na only exists on the surface.
- **The broadening** of Fe 2p and S2p peaks after Ar sputtering is attributed to **sulfur preferential sputtering**.

Pyrite thin films on the quartz



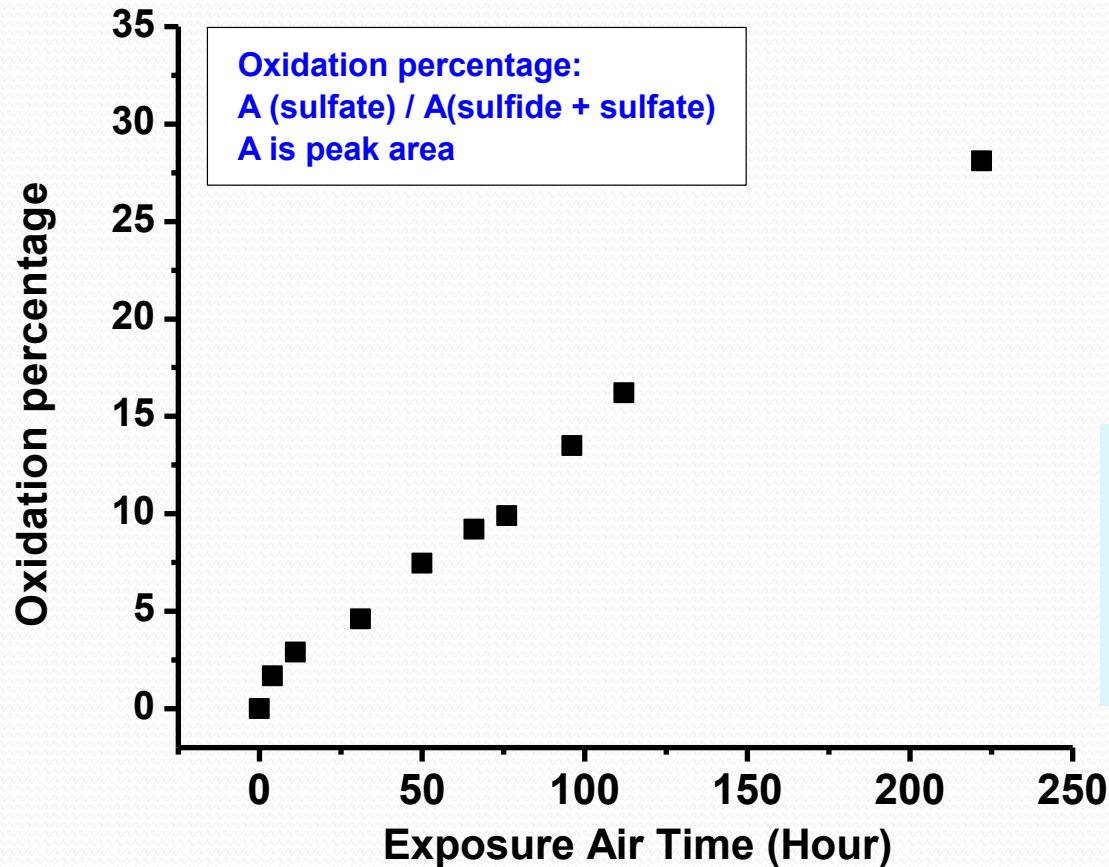
- The composition of mixed acid used for removing the oxide layer is:
0.1% HF, 0.1% Acetic acid, and 0.1% Nitric acid
- The oxide layer can be **removed** by this mixed acid.

Time-dependent oxidation study of acid-etched pyrite thin films on the quartz



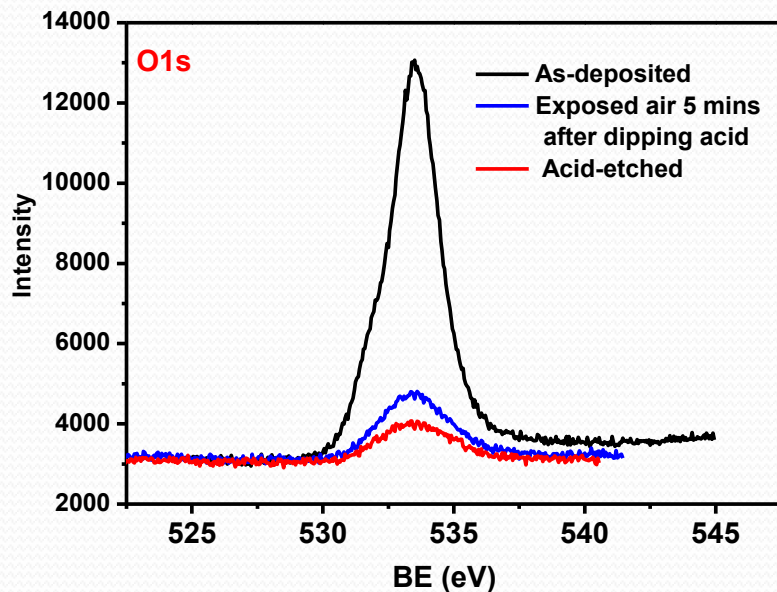
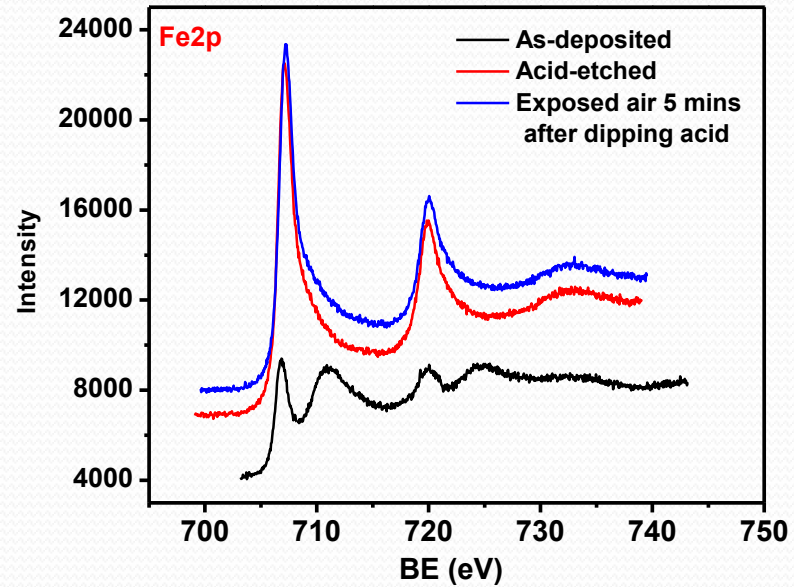
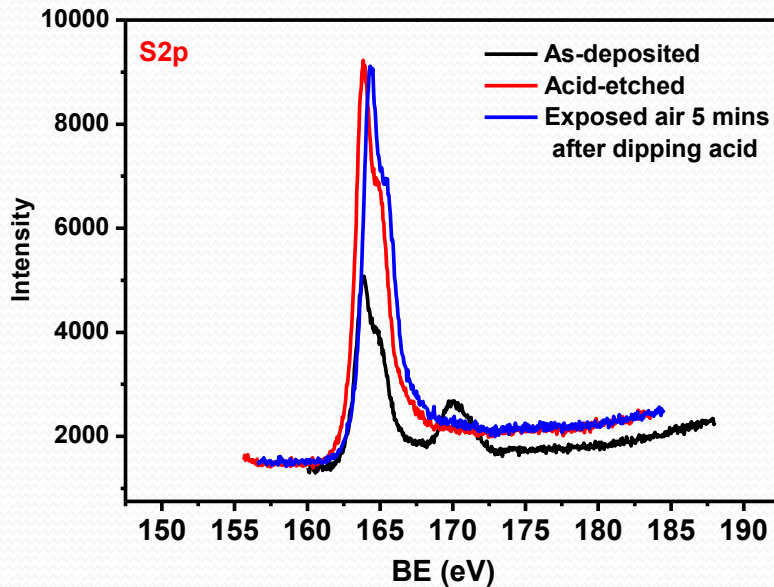
• The oxide layer grows with respect to **exposure air time**.

Time-dependent oxidation study of acid-etched pyrite thin films on quartz



• This oxidation study is still **in progress**, since the oxide layer is **NOT** saturated.

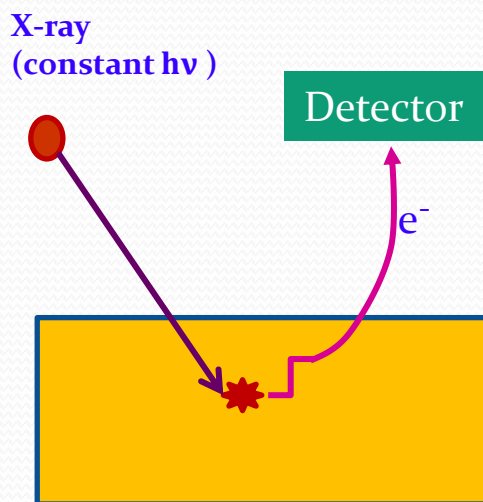
Pyrite thin films on the Si (in Irvine)



- After dipping the acid solution, the oxide layer was removed.
- The acid-etched pyrite keeps **unoxidized** after exposing to air 5 mins.

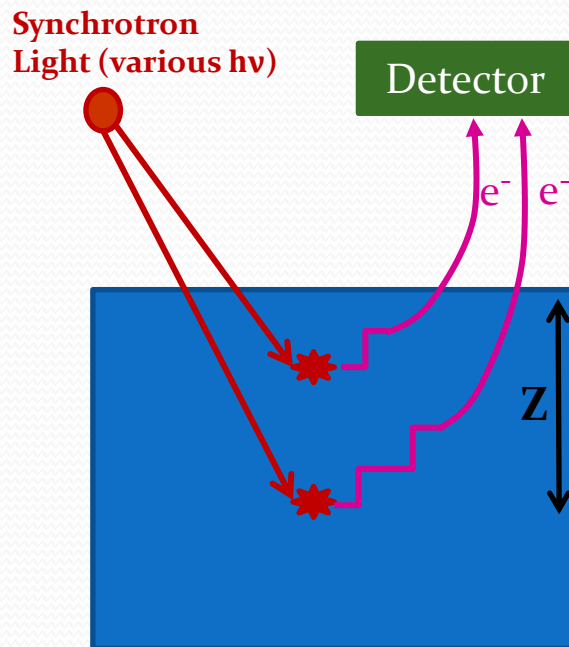
Depth profile experiment and inelastic mean free path (IMFP)

Photoelectron effect

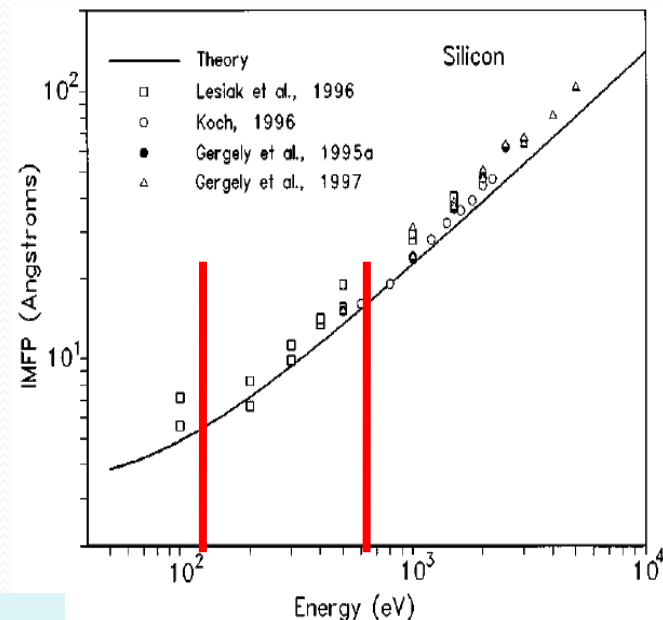


$$E_{\text{kin}} = h\nu - E_B - \Phi_s$$

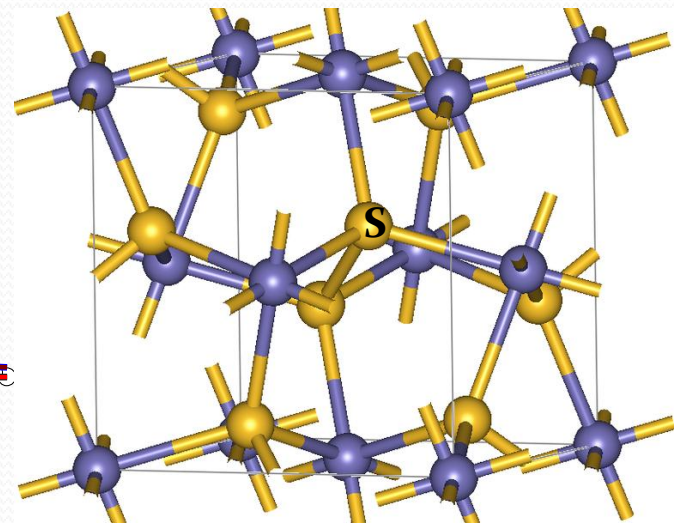
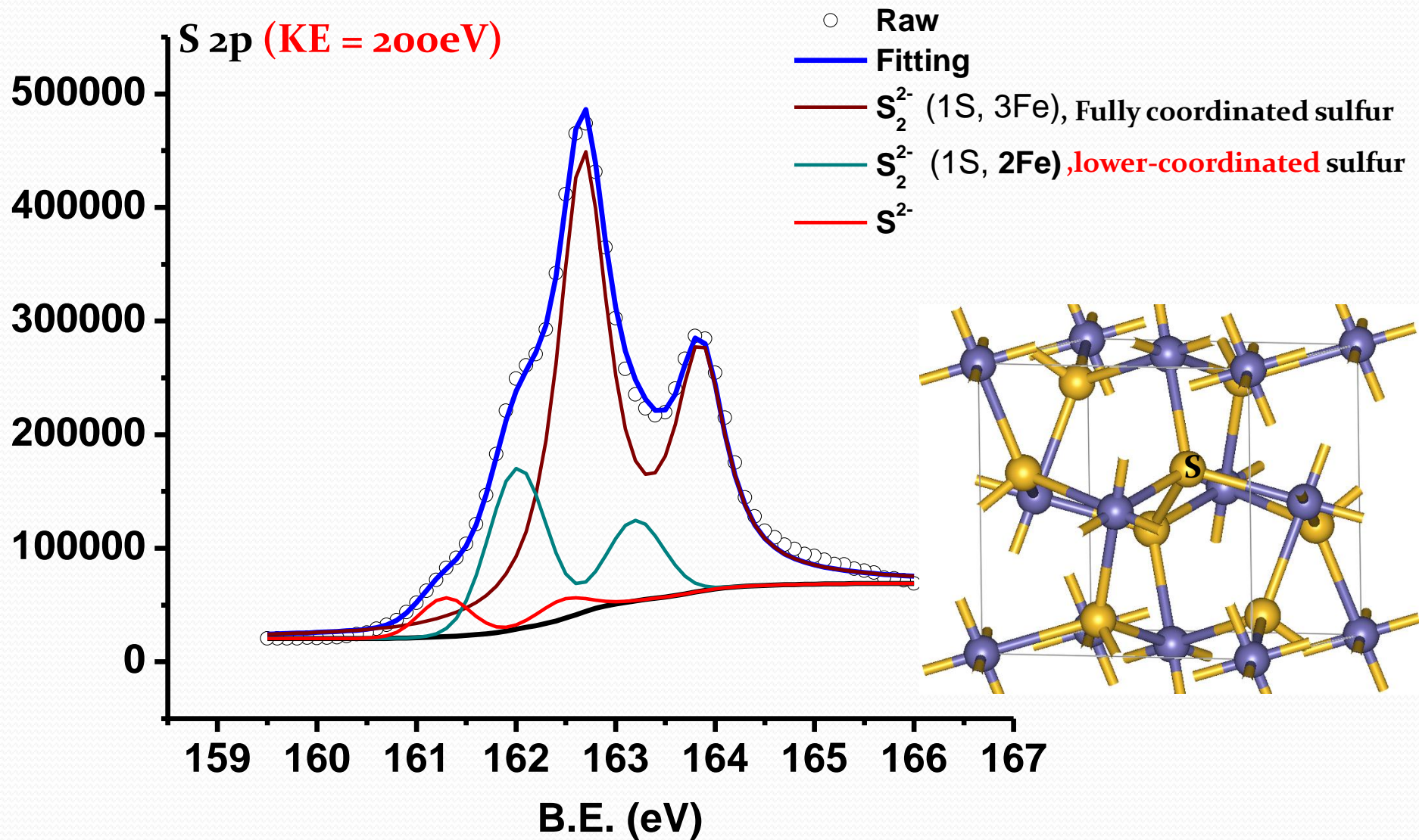
Depth profile experiment



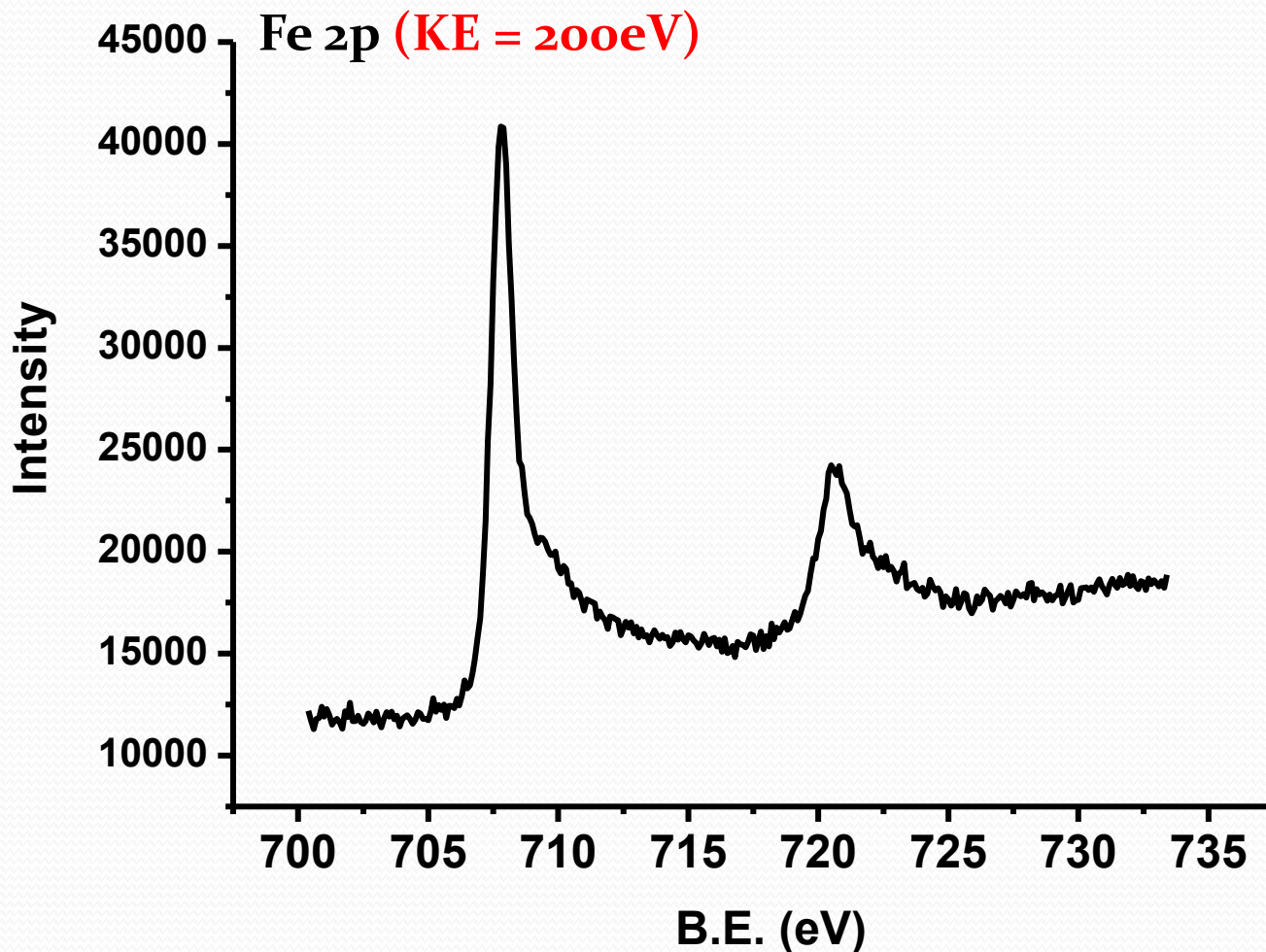
Photoelectrons with different kinetic energies come from **different depth** of the sample.



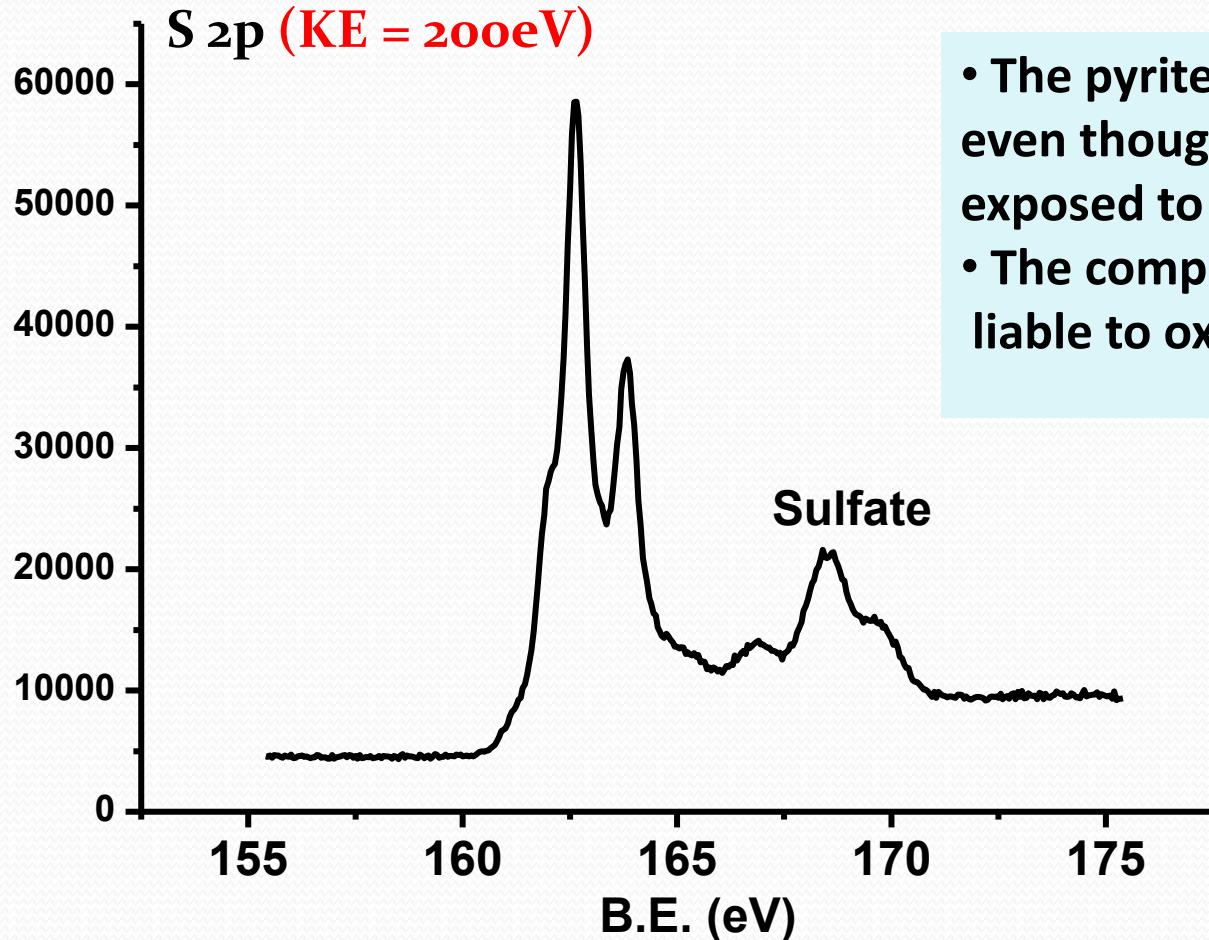
Acid-etched pyrite thin films on Si (in Berkeley)



Acid-etched pyrite thin films on Si (in Berkeley)

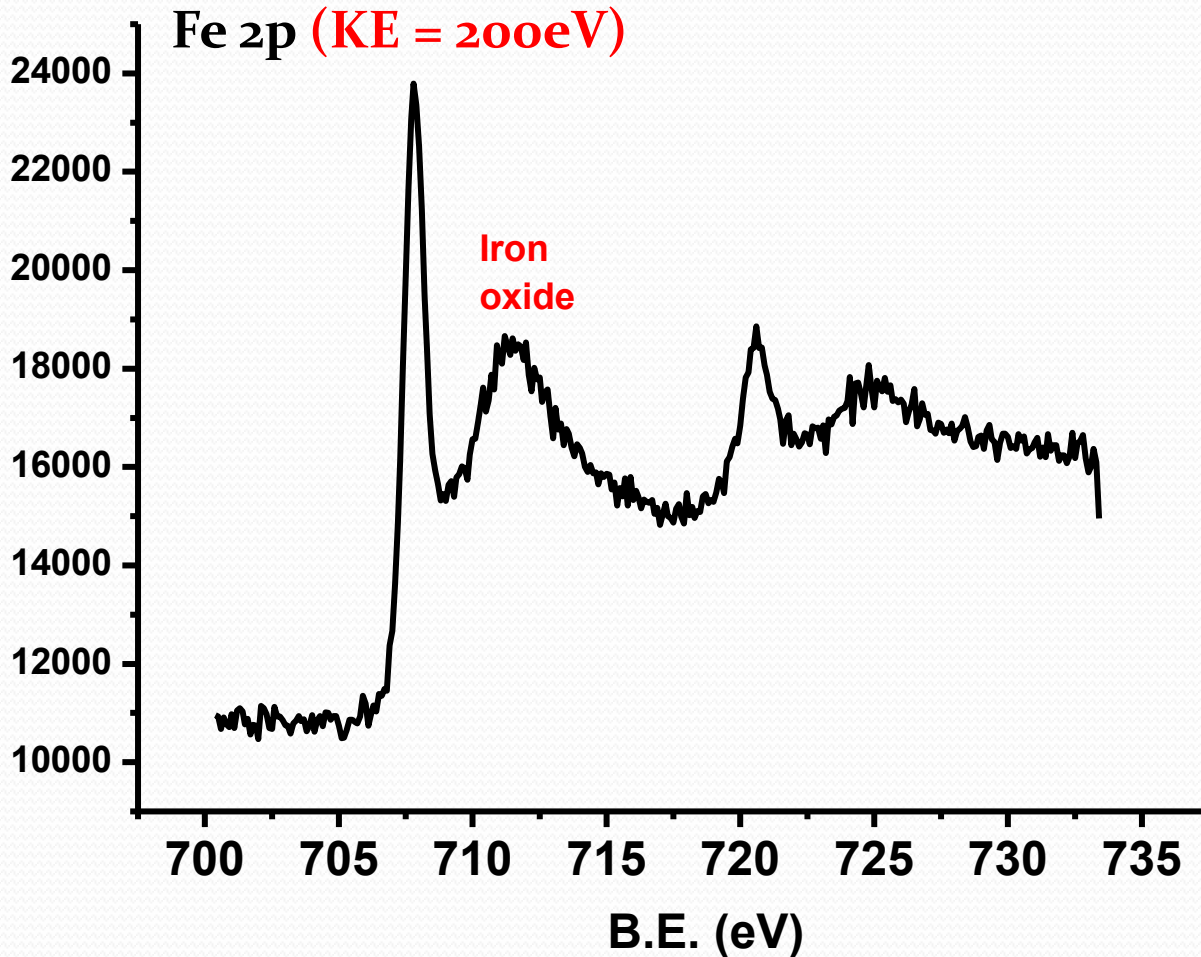


Acid-etched pyrite thin films on Si after exposing to **air 4 hours** (in Berkeley)

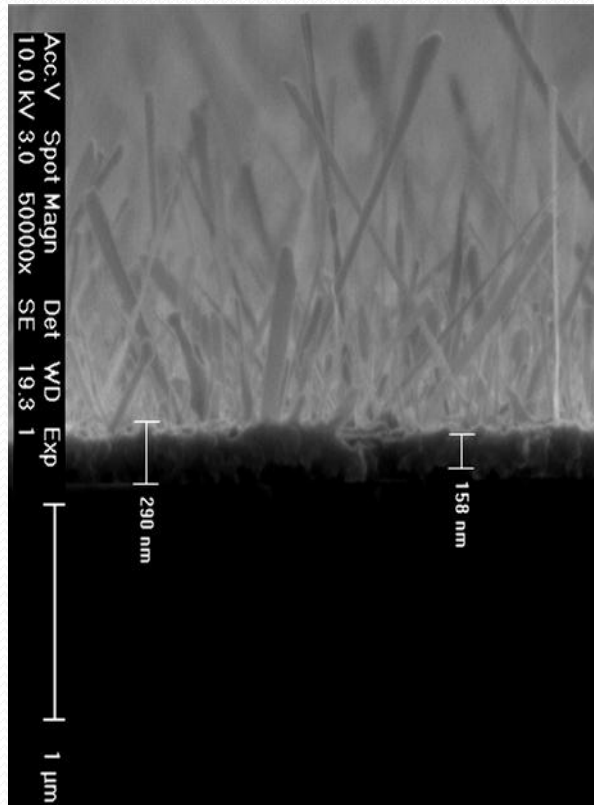


- The pyrite has been **oxidized** even though it only has been exposed to air for **4 hours**.
- The component, **S⁻²**, is the most liable to oxidize.

Acid-etched pyrite thin films on Si after exposing to **air 4 hours** (in Berkeley)

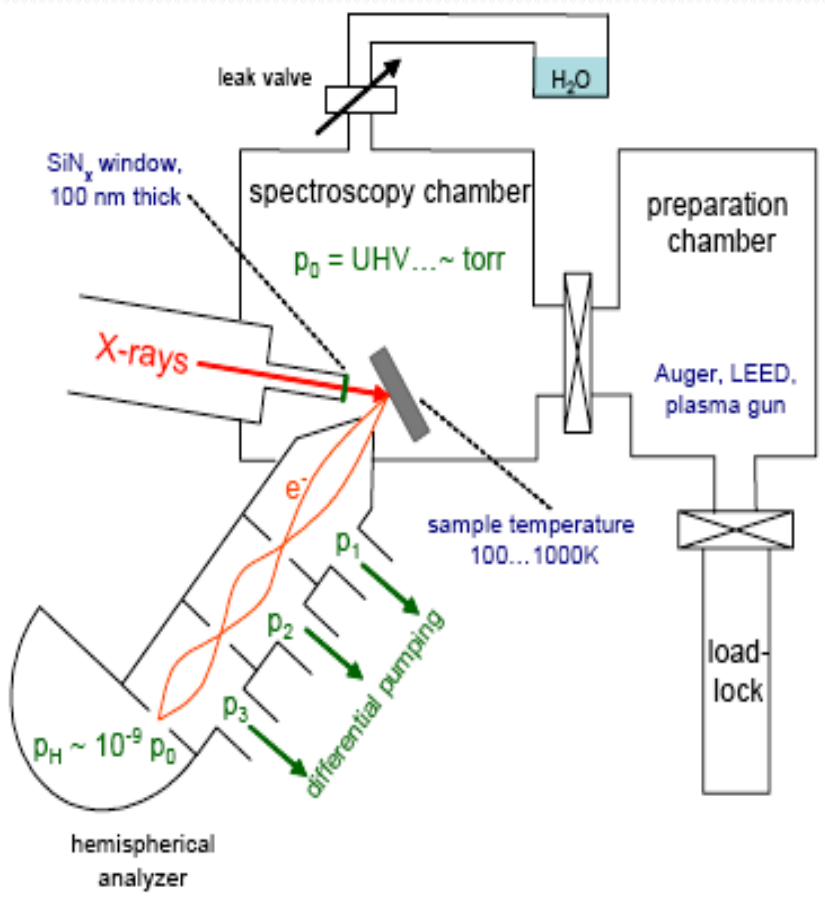


Pyrite thin films on the Si substrate



The **pyrite nanowires** were formed on Si substrate instead of forming pyrite thin films.

Setup of Ambient Pressure XPS



Adjustable experimental conditions:

- Adding H₂O vapor up to **a few torr**.
- **Lower down** temperature (~ -20 degrees) for the sample (change humidity)
- **Rise up** temperature (~ 1000 degrees) for the sample.

Bluhm et al, *Journal of Electron Spectroscopy and Related Phenomena* **2006**, *150*, **86**

Salmeron et al, *Surface Science Reports* **2008**, *63*, **169**.

Conclusion

- Pyrite thin films on the glass
 - **Na migrates to the surface** of the pyrite thin films on the glass.
 - Ar sputtering is **NOT** a good way to remove the oxide layer due to **sulfur preferential sputtering**.
- Pyrite thin films on the quartz
 - The oxidation layers on the surface can be removed by the mixed acid but we still don't know when the oxide **layer will be saturated**.
- Pyrite thin films on the Si substrate
 - Using Synchrotron radiation, **three sulfur surface chemical states** can be revealed and the component, **S⁻²**, is the most liable to oxidize.

Acknowledgements

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